Ultra High Temperature Thermionic Sensor



NETL Crosscutting Research Review Meeting

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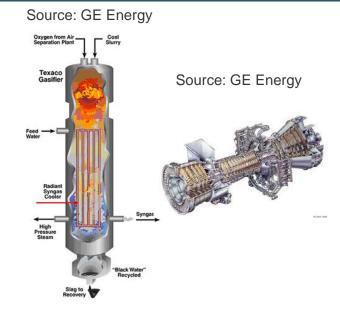
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HEAT Sensor Project Goal Harsh Environment Adaptable Thermionics



- Develop sensors that measure process parameters in:
 - Harsh fuel, oxidizer and combustion product environment
 - High Temperature (750-1600 C)
 - High Pressure (up to 1000 psi)
- Develop sensors that are wireless and selfpowered
 - Generate their own energy to operate and wirelessly transmit the data
 - Avoids wires that may be a reliability or inconvenience concern



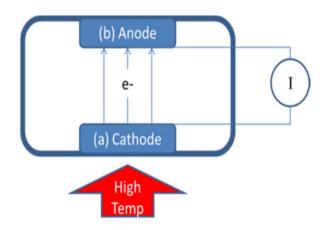


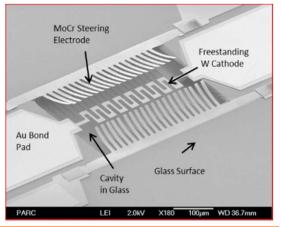
Thermocouple protection system for gasifiers (NETL website)

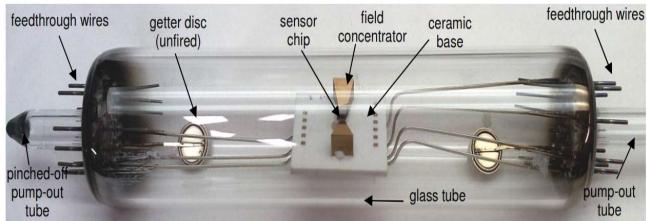


HEAT Sensor Project Concept

- Use Thermionic Materials as Sensors
 - Heat induced flow of electrons from a metal surface
 - Thermionic emissions occur at high temperature without need for external heater source
- La-W and W will be used based upon prior PARC work on a DARPA contract (E-FED)









HEAT Sensor Project Plan

Model and Pattern Thin Film Thermionic Layers

- La-W (2.5 eV) and W (4.5 eV) for temperature and pressure sensing, and basic wireless circuit
- BaO (1.0 eV) for power generation

Develop Experimental System

- Oven with Vacuum Capability
- Electrical Interconnection to Sensor
- Sensor Handling and Measurement

Develop High Temperature Hermetic Package

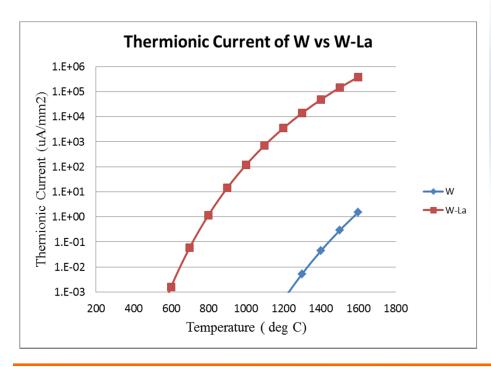
- Use High Temperature Co-Fired Ceramics (99.9% pure alumina)
- Adhesive and Hermetic Sealant Development

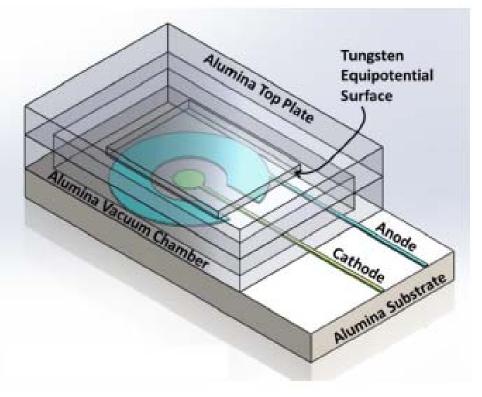


Basic Temperature Sensor

Richardson's Law

$$J = A_{\rm G} T^2 e^{\frac{-W}{kT}}$$

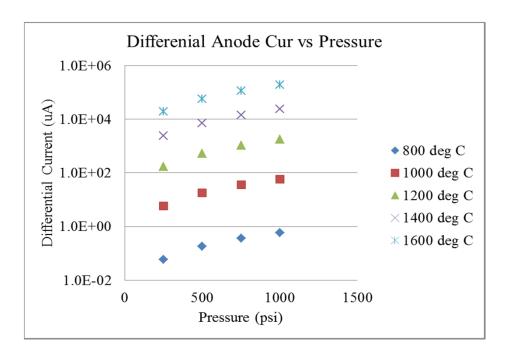


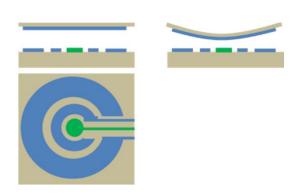


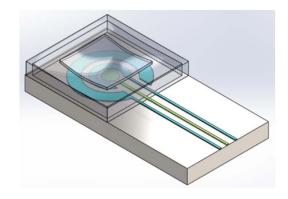


Pressure Sensor

Simulation



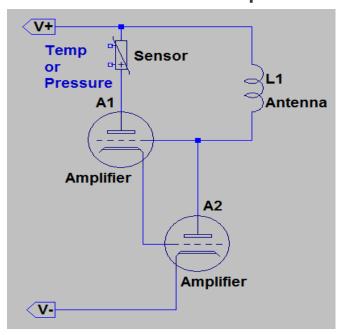




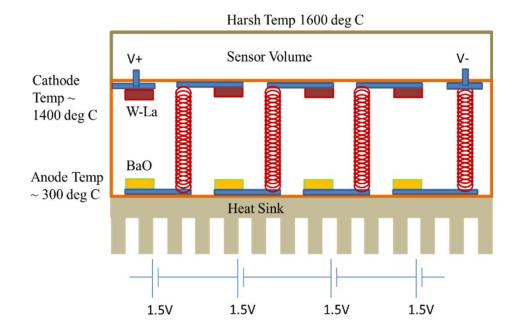
Autonomous Power & Wireless Transmission



Wireless Transmission Circuit Example



Power Generation Concept





Vacuum Oven

Voltage Source

Keithley Current Meter



Turbo Pump (<1e-5 mbar)

> Exhaust Line Port



Instrument Connection

Flange with Pt Wire Connection Up to 8 total connections

Flange Connected to Furnace Tube and Measurement Leads



Pt Wire 100 um diameter Teflon Shrink Wrap

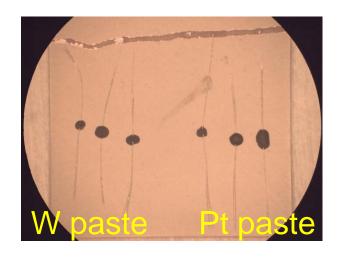
Gas Line Port

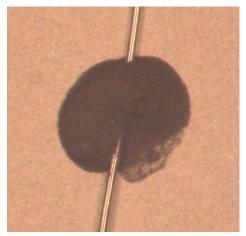


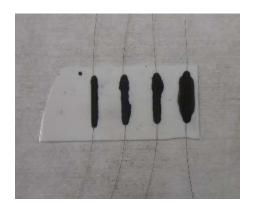
Wire Connection Sensor Film/Package to Pt Wire



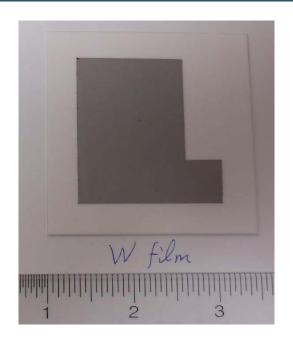
- W and Pt pastes were formulated using alumina adhesives and metal nanoparticles.
- Varying metal loading and application volumes were tested to determine interconnect reliability.
- Both the W and Pt paste worked well and survived temperature runs of 1400C.
- W paste will be used due to ease and cost







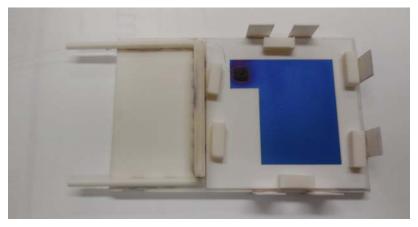
Thermionic Thin Films



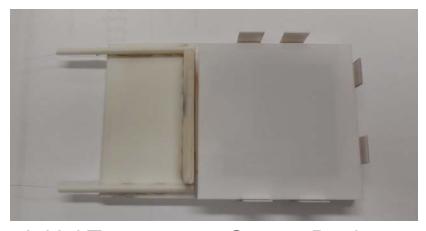


As-deposited W film and W-La film. The sheet resistance is 0.29 Ω /sq. for W film and 1.28 Ω /sq. for W-La film.

Ceramic Fixture for Initial Tests



Ceramic fixture for holding the bottom W film



Initial Temperature Sensor Device

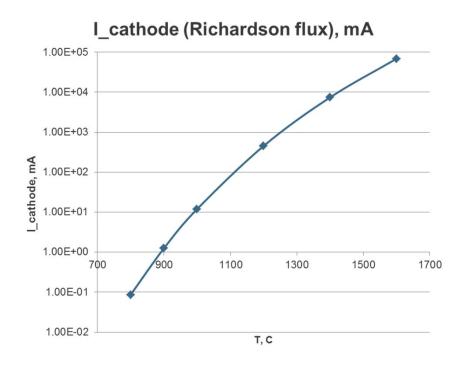
- Setup was put into the tube furnace.
- I-V curves at temperatures between 800 and 1350°C in vacuum were measured.

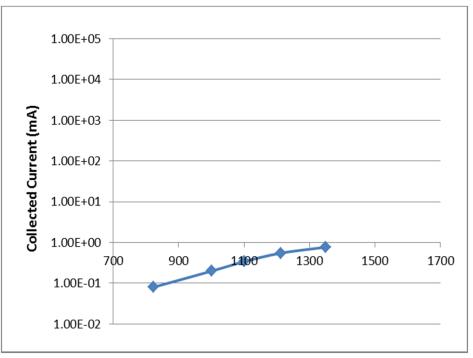


First Data from Thermionic Sensor Element

Simulation Maximum Current Emitted

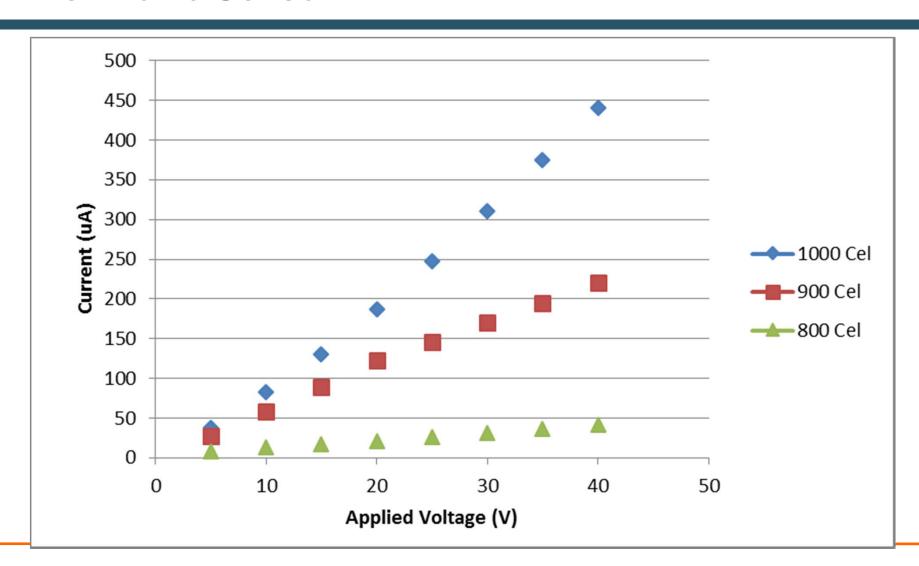
Data -- Collected Current@ 5 mm gap, 25V





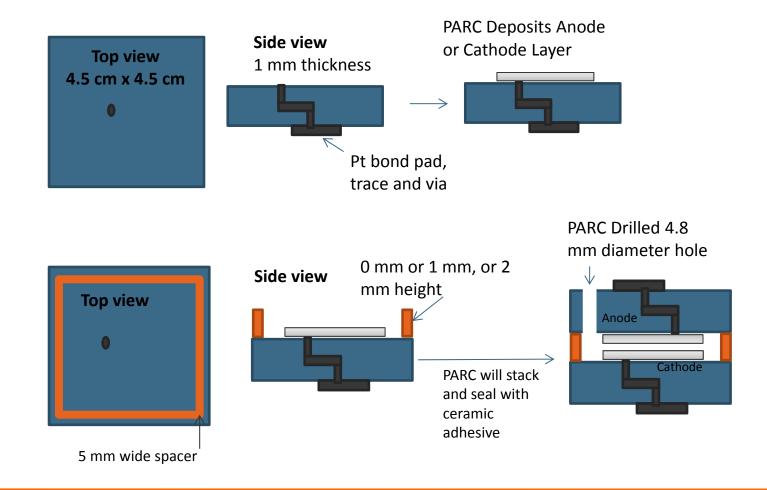


First Temperature Sensing Data from Thermionic Sensor



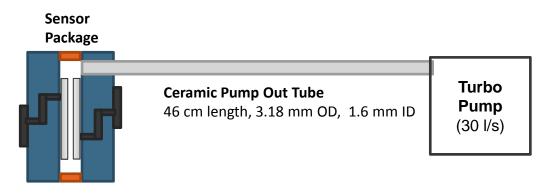


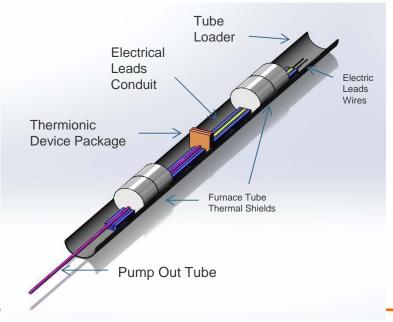
Thermionic HTCC Package Design





Oven Fixture Setup



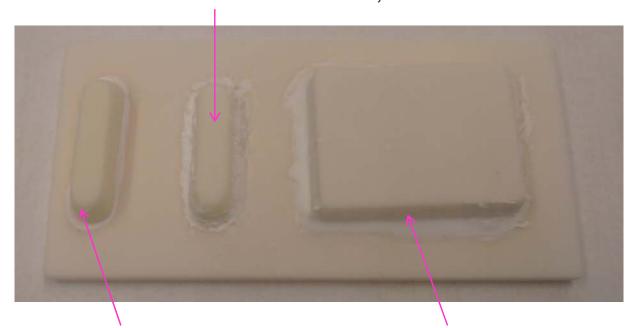






Bonding and Sealing Experiments

Aremco adhesive After 2 times at 1400°C/3hr, air



Cotronics adhesive After 3 times at 1400°C/3hr, air Cotronics adhesive After 1400°C/3hr, air



Hermetic Seal Testing

- Encouraging initial results using Alumina Paste
 - Fired @ 1350C
 - <3.4e-4 mbar base pressure</p>
 - Our target baseline pressure is 1e-4 mbar.
- Planned Improvements
 - Explore application method and firing procedure
 - Seal area and structure modification
 - Decrease paste particle size
 - Add CTE matched high temperature glass filler







Key Milestones

| | Device Interconnect | Device Vacuum | Thin Films |
|--|-------------------------------|-----------------------------------|-----------------|
| Milestone 3 Hermetic Seal | None | Active pumping through tube | None |
| Milestone 4 Temperature Sensor | Pt wire with W paste + Pt via | Active pumping through tube | La-W and W |
| Milestone 6 Pressure Sensor | Pt wire with W paste + Pt via | Active pumping through tube | La-W and W |
| Milestone 9a Self powered and wireless | Pt wire with W paste + Pt via | Active pumping through tube | La-W, W, BaO |
| Milestone 9b Self powered and wireless | None | Self-contained vacuum with getter | La-W, W, BaO |